# V10PWM10C

Vishay General Semiconductor

## High Current Density Surface-Mount TMBS<sup>®</sup> (Trench MOS Barrier Schottky) Rectifier

Ultra Low  $V_F = 0.5 V$  at  $I_F = 2.5 A$ 



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PIN 2 O

### LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	2 x 5 A			
V <sub>RRM</sub>	100 V			
I <sub>FSM</sub>	80 A			
$V_F$ at $I_F$ = 5 A ( $T_J$ = 125 °C)	0.6 V			
T <sub>J</sub> max.	175 °C			
Package	SlimDPAK (TO-252AE)			
Circuit configuration	Common cathode			

### FEATURES

- Very low profile typical height of 1.3 mm
- Trench MOS Schottky technology
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
   Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **TYPICAL APPLICATIONS**

For use in low voltage high frequency DC/DC converters, freewheeling diodes, and polarity protection applications.

## **MECHANICAL DATA**

Case: SlimDPAK (TO-252AE)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

<b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)					
PARAMETER		SYMBOL	V10PWM10C	UNIT	
Device marking code			V10PWM10C		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	100	V		
Maximum average forward rectified current (Fig. 1)	per device	I (1)	10	А	
	per diode	I <sub>F(AV)</sub> <sup>(1)</sup>	5	А	
Peak forward surge current 8.3 ms single half sine-was superimposed on rated load per diode	I <sub>FSM</sub>	80	А		
Operating junction temperature range	T <sub>J</sub> <sup>(2)</sup>	-40 to +175	°C		
Storage temperature range		T <sub>STG</sub>	-55 to +175	°C	

#### Notes

<sup>(1)</sup> With infinite heatsink

 $^{(2)}$  The heat generated must be less than the thermal conductivity from junction to ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ 





COMPLIANT HALOGEN

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ELECTRICAL CHARACTERISTICS (T <sub>J</sub> = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage per diode	I <sub>F</sub> = 2.5 A	T <sub>J</sub> = 25 °C	V <sub>E</sub> <sup>(1)</sup>	0.57	-	V	
	I <sub>F</sub> = 5 A			0.68	0.75		
	I <sub>F</sub> = 2.5 A	T <sub>J</sub> = 125 °C	T 105 %C	VF	0.50	-	v
	I <sub>F</sub> = 5 A			0.60	0.65		
Reverse current per diode	V 70 V	$T_J = 25 \text{ °C}$	I <sub>R</sub> (2)	0.001	-	- mA	
	V <sub>R</sub> = 70 V	T <sub>J</sub> = 125 °C		0.75	-		
	V <sub>R</sub> = 100 V	T <sub>J</sub> = 25 °C		-	0.1		
		T <sub>J</sub> = 125 °C		1.5	5		
Typical junction capacitance per diode	4.0 V, 1 MHz		CJ	500	-	pF	

#### Notes

<sup>(1)</sup> Pulse test: 300 µs pulse width, 1 % duty cycle

<sup>(2)</sup> Pulse test: pulse width  $\leq$  5 ms

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	SYMBOL	V10PWM10C	UNIT			
Typical thermal resistance per device	R <sub>0JA</sub> (1)(2)	65	°C/W			
	R <sub>0JM</sub> <sup>(3)</sup>	2.1	C/W			

#### Notes

<sup>(1)</sup> The heat generated must be less than thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ 

 $^{(2)}$  Free air, mounted on recommended copper pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient

 $^{(3)}$  Mounted on infinite heat sink; thermal resistance  $R_{\theta JM}$  - junction-to-mount

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
V10PWM10C-M3/I	0.20	I	4500	13" diameter plastic tape and reel		
V10PWM10CHM3/I <sup>(1)</sup>	0.20	I	4500	13" diameter plastic tape and reel		

#### Note

(1) AEC-Q101 qualified



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## **RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25$ °C unless otherwise noted)

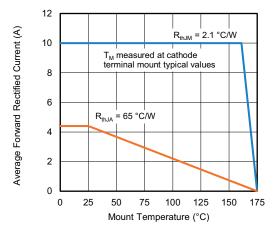


Fig. 1 - Maximum Forward Current Derating Curve

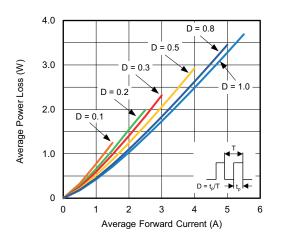


Fig. 2 - Forward Power Loss Characteristics Per Diode

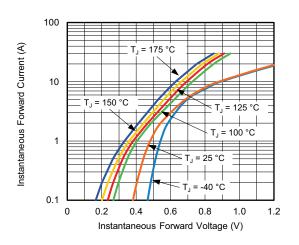


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

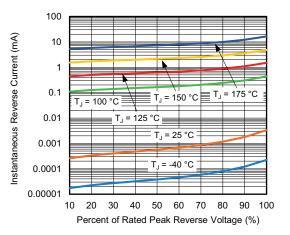


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

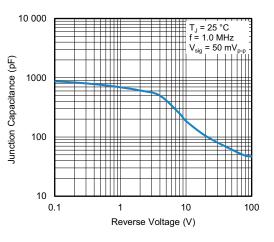
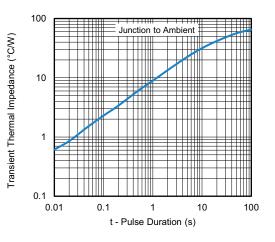


Fig. 5 - Typical Junction Capacitance Per Diode





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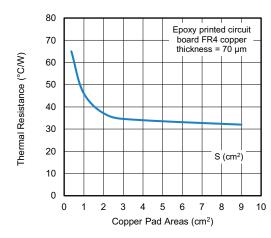
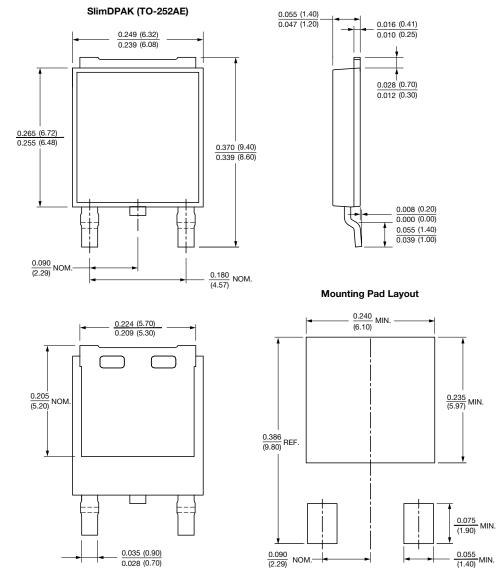


Fig. 7 - Typical Resistance Junction to Ambient vs. Copper Pad Areas

### PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

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